General Description

The MAX30100 is an integrated pulse oximetry and heartrate monitor sensor solution. It combines two LEDs, a photodetector, optimized optics, and low-noise analog signal processing to detect pulse oximetry and heart-rate signals.

The MAX30100 operates from 1.8V and 3.3V power supplies and can be powered down through software with negligible standby current, permitting the power supply to remain connected at all times.

Applications

- Wearable Devices
- **Fitness Assistant Devices**
- **Medical Monitoring Devices**

Benefits and Features

- Complete Pulse Oximeter and Heart-Rate Sensor Solution Simplifies Design
	- Integrated LEDs, Photo Sensor, and High-Performance Analog Front -End
	- Tiny 5.6mm x 2.8mm x 1.2mm 14-Pin Optically Enhanced System-in-Package
- Ultra-Low-Power Operation Increases Battery Life for Wearable Devices
	- Programmable Sample Rate and LED Current for Power Savings
	- Ultra-Low Shutdown Current (0.7µA, typ)
- Advanced Functionality Improves Measurement **Performance**
	- High SNR Provides Robust Motion Artifact Resilience
	- Integrated Ambient Light Cancellation
	- High Sample Rate Capability
	- Fast Data Output Capability

[Ordering Information](#page-25-0) appears at end of data sheet.

System Block Diagram

Absolute Maximum Ratings

Package Thermal Characteristics (Note 1)

OESIP

 Junction-to-Ambient Thermal Resistance (θJA)150°C/W Junction-to-Case Thermal Resistance (θJC).............170°C/W

Continuous Power Dissipation (T_A = +70°C) OESIP (derate 5.8mW/°C above +70°C)464mW Operating Temperature Range........................... -40°C to +85°C Soldering Temperature (reflow).......................................+260°C Storage Temperature Range............................ -40°C to +105°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maximintegrated.com/thermal-tutorial**.

Electrical Characteristics

(V_{DD} = 1.8V, V_{IR} LED+ = V_R LED+ = 3.3V, T_A = +25°C, min/max are from T_A = -40°C to +85°C, unless otherwise noted.) (Note 2)

Electrical Characteristics (continued)

(V_{DD} = 1.8V, V_{IR}_LED+ = V_{R_LED+} = 3.3V, T_A = +25°C, min/max are from T_A = -40°C to +85°C, unless otherwise noted.) (Note 2)

Electrical Characteristics (continued)

(V_{DD} = 1.8V, V_{IRLED+} = V_{RLED+} = 3.3V, T_A = +25°C, min/max are from T_A = -40°C to +85°C, unless otherwise noted.) (Note 2)

Note 2: All devices are 100% production tested at T_A = +25°C. Specifications over temperature limits are guaranteed by Maxim Integrated's bench or proprietary automated test equipment (ATE) characterization.

Note 3: Specifications are guaranteed by Maxim Integrated's bench characterization and by 100% production test using proprietary ATE setup and conditions.

Note 4: For design guidance only. Not production tested.

Figure 1. I2C-Compatible Interface Timing Diagram

Typical Operating Characteristics

(V_{DD} = 1.8V, V_{IR} LED+ = V_R LED+ = 3.3V, T_A = +25°C, unless otherwise noted.)

Typical Operating Characteristics (continued)

 $(V_{DD} = 1.8V, V_{IR_LED+} = V_{R_LED+} = 3.3V, T_A = +25^{\circ}C,$ unless otherwise noted.)

Pin Configuration

Pin Description

Functional Diagram

Detailed Description

The MAX30100 is a complete pulse oximetry and heartrate sensor system solution designed for the demanding requirements of wearable devices. The MAX30100 provides very small total solution size without sacrificing optical or electrical performance. Minimal external hardware components are needed for integration into a wearable device.

The MAX30100 is fully configurable through software registers, and the digital output data is stored in a 16-deep FIFO within the device. The FIFO allows the MAX30100 to be connected to a microcontroller or microprocessor on a shared bus, where the data is not being read continuously from the device's registers.

SpO2 Subsystem

The SpO₂ subsystem in the MAX30100 is composed of ambient light cancellation (ALC), 16-bit sigma delta ADC, and proprietary discrete time filter.

The $SpO₂$ ADC is a continuous time oversampling sigma delta converter with up to 16-bit resolution. The ADC output data rate can be programmed from 50Hz to 1kHz. The MAX30100 includes a proprietary discrete time filter to reject 50Hz/60Hz interference and low-frequency residual ambient noise.

Temperature Sensor

The MAX30100 has an on-chip temperature sensor for (optionally) calibrating the temperature dependence of the SpO2 subsystem.

The $SpO₂$ algorithm is relatively insensitive to the wavelength of the IR LED, but the red LED's wavelength is critical to correct interpretation of the data. The temperature sensor data can be used to compensate the $SpO₂$ error with ambient temperature changes.

LED Driver

The MAX30100 integrates red and IR LED drivers to drive LED pulses for $SpO₂$ and HR measurements. The LED current can be programmed from 0mA to 50mA (typical only) with proper supply voltage. The LED pulse width can be programmed from 200µs to 1.6ms to optimize measurement accuracy and power consumption based on use cases.

Table 1. Register Maps and Descriptions

*XX denotes any 2-digit hexidecimal number (00 to FF). Contact Maxim Integrated for the Revision ID number assigned for your product.

Interrupt Status (0x00)

There are 5 interrupts and the functionality of each is exactly the same: pulling the active-low interrupt pin into its low state until the interrupt is cleared.

The interrupts are cleared whenever the interrupt status register is read, or when the register that triggered the interrupt is read. For example, if the SpO₂ sensor triggers an interrupt due to finishing a conversion, reading either the FIFO data register or the interrupt register clears the interrupt pin (which returns to its normal high state), and also clears all the bits in the interrupt status register to zero.

Bit 7: FIFO Almost Full Flag (A_FULL)

In SpO₂ and heart-rate modes, this interrupt triggers when the FIFO write pointer is the same as the FIFO read pointer minus one, which means that the FIFO has only one unwritten space left. If the FIFO is not read within the next conversion time, the FIFO becomes full and future data is lost.

Bit 6: Temperature Ready Flag (TEMP_RDY)

When an internal die temperature conversion is finished, this interrupt is triggered so the processor can read the temperature data registers.

Bit 5: Heart Rate Data Ready (HR_RDY)

In heart rate or $SPO₂$ mode, this interrupt triggers after every data sample is collected. A heart rate data sample consists of one IR data point only. This bit is automatically cleared when the FIFO data register is read.

Bit 4: SpO2 Data Ready (SPO2_RDY)

In SpO₂ mode, this interrupt triggers after every data sample is collected. An SpO₂ data sample consists of one IR and one red data points. This bit is automatically cleared when the FIFO data register is read.

Bit 3: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 2: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 1: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 0: Power Ready Flag (PWR_RDY)

On power-up or after a brownout condition, when the supply voltage V_{DD} transitions from below the UVLO voltage to above the UVLO voltage, a power-ready interrupt is triggered to signal that the IC is powered up and ready to collect data.

Interrupt Enable (0x01)

Each source of hardware interrupt, with the exception of power ready, can be disabled in a software register within the MAX30100 IC. The power-ready interrupt cannot be disabled because the digital state of the MAX30100 is reset upon a brownout condition (low power-supply voltage), and the default state is that all the interrupts are disabled. It is important for the system to know that a brownout condition has occurred, and the data within the device is reset as a result.

When an interrupt enable bit is set to zero, the corresponding interrupt appears as 1 in the interrupt status register, but the INT pin is not pulled low.

The four unused bits (B3:B0) should always be set to zero (disabled) for normal operation.

FIFO (0x02–0x05)

FIFO Write Pointer

The FIFO write pointer points to the location where the MAX30100 writes the next sample. This pointer advances for each sample pushed on to the FIFO. It can also be changed through the I²C interface when MODE[2:0] is nonzero.

FIFO Overflow Counter

When the FIFO is full, samples are not pushed on to the FIFO, samples are lost. OVF_COUNTER counts the number of samples lost. It saturates at 0xF. When a complete sample is popped from the FIFO (when the read pointer advances), OVF COUNTER is reset to zero.

FIFO Read Pointer

The FIFO read pointer points to the location from where the processor gets the next sample from the FIFO via the I2C interface. This advances each time a sample is popped from the FIFO. The processor can also write to this pointer after reading the samples, which would allow rereading samples from the FIFO if there is a data communication error.

FIFO Data

The circular FIFO depth is 16 and can hold up to 16 samples of $SpO₂$ channel data (Red and IR). The FIFO_DATA register in the $12C$ register map points to the next sample to be read from the FIFO. FIFO_RD_PTR points to this sample. Reading FIFO_DATA register does not automatically increment the register address; burst reading this register reads the same address over and over. Each sample is 4 bytes of data, so this register has to be read 4 times to get one sample.

The above registers can all be written and read, but in practice, only the FIFO_RD_PTR register should be written to in operation. The others are automatically incremented or filled with data by the MAX30100. When starting a new $SpO₂$

or heart-rate conversion, it is recommended to first clear the FIFO_WR_PTR, OVF_COUNTER, and FIFO_RD_PTR registers to all zeros (0x00) to ensure the FIFO is empty and in a known state. When reading the MAX30100 registers in one burst-read I2C transaction, the register address pointer typically increments so that the next byte of data sent is from the next register, etc. The exception to this is the FIFO data register, register 0x05. When reading this register, the address pointer does not increment, but the FIFO_RD_PTR does. So the next byte of data sent will represent the next byte of data available in the FIFO.

Reading from the FIFO

Normally, reading registers from the I2C interface autoincrements the register address pointer, so that all the registers can be read in a burst read without an I2C restart event. In the MAX30100, this holds true for all registers except for the FIFO DATA register (0x05).

Reading the FIFO_DATA register does not automatically increment the register address; burst reading this register reads the same address over and over. Each sample is 4 bytes of data, so this register has to be read 4 times to get one sample.

The other exception is 0xFF, reading more bytes after the 0xFF register does not advance the address pointer back to 0x00, and the data read is not meaningful.

FIFO Data Structure

The data FIFO consists of a 16-sample memory bank that stores both IR and RED ADC data. Since each sample consists of one IR word and one RED word, there are 4 bytes of data for each sample, and therefore, 64 total bytes of data can be stored in the FIFO. [Figure 2](#page-12-0) shows the structure of the FIFO graphically.

The FIFO data is left-justified as shown in [Table 1](#page-9-0); i.e. the MSB bit is always in the bit 15 position regardless of ADC resolution.

Each data sample consists of an IR and a red data word (2 registers), so to read one sample requires 4 I2C byte reads in a row. The FIFO read pointer is automatically incremented after each 4-byte sample is read.

In heart-rate only mode, the 3rd and 4th bytes of each sample return zeros, but the basic structure of the FIFO remains the same.

Write/Read Pointers

Table 2. FIFO Data

Figure 2. Graphical Representation of the FIFO Data Register

The locations to store new data, and the read pointer for reading data, are used to control the flow of data in the FIFO. The write pointer increments every time a new sample is added to the FIFO. The read pointer is incremented automatically every time a sample is read from the FIFO. To reread a sample from the FIFO, decrement its value by one and read the data register again.

The SpO₂ write/read pointers should be cleared (back to 0x0) upon entering SpO₂ mode or heart-rate mode, so that there is no old data represented in the FIFO. The pointers are not automatically cleared when changing modes, but they are cleared if V_{DD} is power cycled so that the V_{DD} voltage drops below its UVLO voltage.

Pseudo-Code Example of Reading Data from FIFO

First transaction: Get the FIFO_WR_PTR:

START; Send device address + write mode Send address of FIFO WR PTR; REPEATED_START; Send device address + read mode Read FIFO WR PTR; STOP;

The central processor evaluates the number of samples to be read from the FIFO:

```
NUM_AVAILABLE_SAMPLES = FIFO_WR_PTR – FIFO_RD_PTR
(Note: pointer wrap around should be taken into account)
NUM SAMPLES TO READ = \lt less than or equal to NUM AVAILABLE SAMPLES >
```
Second transaction: Read NUM_SAMPLES_TO_READ **samples from the FIFO**:

```
START;
Send device address + write mode
Send address of FIFO DATA;
REPEATED_START;
Send device address + read mode
for (i = 0; i < NUM SAMPLES TO READ; i++) {
Read FIFO_DATA;
Save IR[15:8];
Read FIFO_DATA;
Save IR[7:0];
Read FIFO_DATA;
Save R[15:8];
Read FIFO_DATA;
Save R[7:0];
     }
STOP;
```
Third transaction: Write to FIFO_RD_PTR register. If the second transaction was successful, FIFO_RD_PTR points to the next sample in the FIFO, and this third transaction is not necessary. Otherwise, the processor updates the FIFO_RD_PTR appropriately, so that the samples are reread.

START;

```
Send device address + write mode
Send address of FIFO RD PTR;
Write FIFO RD PTR;
STOP;
```
Mode Configuration (0x06)

Bit 7: Shutdown Control (SHDN)

The part can be put into a power-save mode by setting this bit to one. While in power-save mode, all registers retain their values, and write/read operations function as normal. All interrupts are cleared to zero in this mode.

Bit 6: Reset Control (RESET)

When the RESET bit is set to one, all configuration, threshold, and data registers are reset to their power-on-state. The only exception is writing both RESET and TEMP_EN bits to one at the same time since temperature data registers 0x16 and 0x17 are not cleared. The RESET bit is cleared automatically back to zero after the reset sequence is completed.

Bit 3: Temperature Enable (TEMP_EN)

This is a self-clearing bit which, when set, initiates a single temperature reading from the temperature sensor. This bit is cleared automatically back to zero at the conclusion of the temperature reading when the bit is set to one in heart rate or SpO₂ mode.

Bits 2:0: Mode Control

These bits set the operating state of the MAX30100. Changing modes does not change any other setting, nor does it erase any previously stored data inside the data registers.

Table 3. Mode Control

SpO2 Configuration (0x07)

Bit 6: SpO2 High Resolution Enable (SPO2_HI_RES_EN)

Set this bit high. The SpO₂ ADC resolution is 16-bit with 1.6ms LED pulse width.

Bit 5: Reserved. Set low (default).

Bit 4:2: SpO2 Sample Rate Control

These bits define the effective sampling rate, with one sample consisting of one IR pulse/conversion and one RED pulse/ conversion.

The sample rate and pulse width are related, in that the sample rate sets an upper bound on the pulse width time. If the user selects a sample rate that is too high for the selected LED_PW setting, the highest possible sample rate will instead be programmed into the register.

Bits 1:0: LED Pulse Width Control

These bits set the LED pulse width (the IR and RED have the same pulse width), and therefore, indirectly set the integration time of the ADC in each sample. The ADC resolution is directly related to the integration time.

Table 4. SpO₂ Sample Rate Control

Table 5. LED Pulse Width Control

LED Configuration (0x09)

Bits 7:4: Red LED Current Control

These bits set the current level of the Red LED as in Table 6.

Bits 3:0: IR LED Current Control

These bits set the current level of the IR LED as in Table 6.

Table 6. LED Current Control

*Actual measured LED current for each part can vary widely due to the proprietary trim methodology.

Temperature Data (0x16–0x17)

Temperature Integer

The on-board temperature ADC output is split into two registers, one to store the integer temperature and one to store the fraction. Both should be read when reading the temperature data, and the following equation shows how to add the two registers together:

TMEASURED = TINTEGER + TFRACTION

This register stores the integer temperature data in two's complement format, where each bit corresponds to degree Celsius.

Table 7. Temperature Integer

Temperature Fraction

This register stores the fractional temperature data in increments of 0.0625° C (1/16th of a degree).

If this fractional temperature is paired with a negative integer, it still adds as a positive fractional value $(e.g., -128\degree C + 0.5\degree C = -127.5\degree C)$.

Applications Information

Sampling Rate and Performance

The MAX30100 ADC is a 16-bit sigma delta converter. The ADC sampling rate can be configured from 50sps to 1ksps. The maximum sample rate for the ADC depends on the selected pulse width, which in turn, determines the ADC resolution. For instance, if the pulse width is set to 200µs, then the ADC resolution is 13 bits and all sample rates from 50sps to 1ksps are selectable. However, if the pulse width is set to 1600µs, then only sample rates of 100sps and 50sps can be set. The allowed sample rates for both $SpO₂$ and HR mode are summarized in [Table 8](#page-18-0) and [Table](#page-18-1) 9.

Power Considerations

The LEDs in MAX30100 are pulsed with a low duty cycle for power savings, and the pulsed currents can cause ripples in the LED power supply. To ensure these pulses do not translate into optical noise at the LED outputs, the power supply must be designed to handle peak LED current. Ensure that the resistance and inductance from the

Table 8. SpO2 Mode (Allowed Settings) Table 9. Heart-Rate Mode

power supply (battery, DC/DC converter, or LDO) to the device LED+ pins is much smaller than 1Ω, and that there is at least 1µF of power-supply bypass capacitance to a low impedance ground plane. The decoupling capacitor should be located physically as close as possible to the MAX30100 device.

In the heart-rate only mode, the red LED is inactive, and only the IR LED is used to capture optical data and determine the heart rate. This mode allows power savings due to the red LED being off; in addition, the IR_LED+ power supply can be reduced to save power because the forward voltage of the IR LED is significantly less than that of the red LED.

The average I_{DD} and LED current as function of pulse width and sampling rate is summarized in [Table 1](#page-19-0)0 to [Table 13](#page-19-1).

(Allowed Settings)

Table 10. SpO2 Mode: Average IDD Current (μ A) R PA = 0x3, IR PA = 0x3

Table 11. SpO2 Mode: Average LED Current (mA) R_PA = 0x3, IR_PA = 0x3

Hardware Interrupt

The active-low interrupt pin pulls low when an interrupt is triggered. The pin is open-drain and requires a pullup resistor or current source to an external voltage supply (up to +5V from GND). The interrupt pin is not designed to sink large currents, so the pullup resistor value should be large, such as 4.7kΩ.

The internal FIFO stores up to 16 samples, so that the system processor does not need to read the data after

Table 12. Heart-Rate Mode: Average IDD Current (µA) IR_PA = 0x3

Table 13. Heart-Rate Mode: Average LED Current (mA) IR_PA = 0x3

every sample. Temperature data may be needed to properly interpret $SpO₂$ data, but the temperature does not need to be sampled very often—once a second or every few seconds should be sufficient. In heart-rate mode temperature information is not necessary.

Table 14. Red LED Current Settings vs. LED Temperature Rise

Timing for Measurements and Data Collection

Timing in SpO2 Mode

Figure 3. Timing for Data Acquisition and Communication When in SpO2 Mode

Table 15. Events Sequence for Figure 3 in SpO2 Mode

Timing in Heart-Rate Mode

Figure 4. Timing for Data Acquisition and Communication When in Heart Rate Mode

Table 16. Events Sequence for Figure 4 in Heart-Rate Mode

Power Sequencing and Requirements

Power-Up Sequencing

[Figure 5](#page-22-0) shows the recommended power-up sequence for the MAX30100.

It is recommended to power the V_{DD} supply first, before the LED power supplies (R_LED+, IR_LED+). The interrupt and I2C pins can be pulled up to an external voltage even when the power supplies are not powered up.

After the power is established, an interrupt occurs to alert the system that the MAX30100 is ready for operation. Reading the I2C interrupt register clears the interrupt, as shown in [Figure 5.](#page-22-0)

Power-Down Sequencing

The MAX30100 is designed to be tolerant of any powersupply sequencing on power-down.

I2C Interface

The MAX30100 features an I2C/SMBus-compatible, 2-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA and SCL facilitate communication between the MAX30100 and the master at clock rates up to 400kHz. [Figure 1](#page-4-0) shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the MAX30100 by transmitting the proper slave address followed by data. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the MAX30100 is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the MAX30100 transmits the proper slave address followed by a series of nine SCL pulses.

The MAX30100 transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START (S) or REPEATED START (Sr) condition, a not acknowledge, and a STOP (P) condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500Ω, is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than 500Ω, is required on SCL if there are multiple masters on the bus, or if the single master has an open-drain SCL output.

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals. See the *[START and STOP Conditions](#page-23-0)* section.

Figure 5. Power-Up Sequence of the Power-Supply Rails

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high ([Figure 6](#page-23-1)). A START condition from the master signals the beginning of a transmission to the MAX30100. The master terminates transmission, and frees the bus, by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

Early STOP Conditions

The MAX30100 recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

Slave Address

A bus master initiates communication with a slave device by issuing a START condition followed by the 7-bit slave ID. When idle, the MAX30100 waits for a START condition followed by its slave ID. The serial interface compares each slave ID bit by bit, allowing the interface to power down and disconnect from SCL immediately if an incorrect slave ID is detected. After recognizing a START condition followed by the correct slave ID, the MAX30100 is ready to accept or send data. The LSB of the slave

ID word is the Read/Write (R/\overline{W}) bit. R/ \overline{W} indicates whether the master is writing to or reading data from the MAX30100. R/ \overline{W} = 0 selects a write condition. R/ \overline{W} = 1 selects a read condition). After receiving the proper slave ID, the MAX30100 issues an ACK by pulling SDA low for one clock cycle.

The MAX30100 slave ID consists of seven fixed bits, B7–B1 (set to 0b1010111). The most significant slave ID bit (B7) is transmitted first, followed by the remaining bits. [Table 18](#page-23-2) shows the possible slave IDs of the device.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX30100 uses to handshake receipt each byte of data when in write mode [\(Figure 7\)](#page-23-3). The MAX30100 pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master will retry communication. The master pulls down SDA during the 9th clock cycle to acknowledge receipt of data when the MAX30100 is in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not-acknowledge is sent when the master reads the final byte of data from the MAX30100, followed by a STOP condition.

Table 17. Slave ID Description

Figure 6. START, STOP, and REPEATED START Conditions Figure 7. Acknowledge

Write Data Format

For the write operation, send the slave ID as the first byte followed by the register address byte and then one or more data bytes. The register address pointer increments automatically after each byte of data received. For example, the entire register bank can be written by at one time. Terminate the data transfer with a STOP condition. The write operation is shown in [Figure 8](#page-24-0).

The internal register address pointer increments automatically, so writing additional data bytes fill the data registers in order.

Read Data Format

For the read operation, two I2C operations must be performed. First, the slave ID byte is sent followed by the I2C register that you wish to read. Then a REPEATED START (Sr) condition is sent, followed by the read slave ID. The MAX30100 then begins sending data beginning with the register selected in the first operation. The read pointer increments automatically, so the MAX30100 continues sending data from additional registers in sequential order until a STOP (P) condition is received. The exception to this is the FIFO_DATA register, at which the read pointer no longer increments when reading additional bytes. To read the next register after FIFO_DATA, an I2C write command is necessary to change the location of the read pointer.

An initial write operation is required to send the read register address.

Data is sent from registers in sequential order, starting from the register selected in the initial I2C write operation. If the FIFO_DATA register is read, the read pointer does not automatically increment, and subsequent bytes of data contain the contents of the FIFO.

Figure 8. Writing One Data Byte to the MAX30100

Figure 9. Reading One Byte of Data from the MAX30100

Figure 10. Reading Multiple Bytes of Data from the MAX30100

Typical Application Circuit

Ordering Information Chip Information

+Denotes a lead(Pb)-free/RoHS-compliant package.

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to **www.maximintegrated.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package Information (continued)

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Revision History

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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